

RF 15 R - Low tactile switch, non-illuminated, gold contacts

3.14.100.501/0000



Length15 mmWidth15 mmOverall height9.7 mmMechanical design9.7 mmMechanical designMountingSoldering in PCBTerminalsTerminalsTHTContact systemsnap-action contactContact arrangement1 NOContact materialsAuIlluminationnot illuminatedMechanical characteristicsOperating force max.Operating force max. $2.9^{\pm 0.6}$ NSwitching travel $0.5^{\pm 0.2}$ mmRobustness max.with through-plated PCB 100 NElectrical characteristicsElectrical characteristicsRated voltage min.Au: 0.02 V, Ag: 3 VRated voltage max. 35 VRated current min.Au: 0.01 mA, Ag: 0.1 mARated current max.Au: 100 mA, Ag: 25 mARated power max. (ohmic load)Au: 2 W, Ag: 12.5 WContact resistance $10^{9} \Omega$ Other specifications-25 °CAmbient temp. operating min. -25 °CAnvier temp. (opera	General information	
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Manual soldering 350 °C / 5 sec. max.	Solderability / solder heat resistance	
	Wave soldering	260 °C max.
ROHS compliant yes	Manual soldering	<u>350 °C / 5 sec. max.</u>
	ROHS compliant	yes
REACH compliant yes	REACH compliant	yes

Technical data are approximate and intended solely for general orientation in the selection of a product. Subject to modifications and errors. Images and other graphics may only be similar. For more information, refer to www.rafi.de chapter Imprint / Data Protection.





RF 15 R high, with 3 mm LED, green





